

# NEC'S WIDE BAND SINGLE CONTROL CMOS SPDT SWITCH

# **UPD5710TK**

#### **FEATURES**

## • SUPPLY VOLTAGE: 1.8 to 3.3 V (2.8 V TYP.)

· SINGLE SWITCH CONTROL VOLTAGE:

 $V_{cont (H)} = 1.8 \text{ to } 3.3 \text{ V } (2.8 \text{ V TYP.})$  $V_{cont (L)} = -0.2 \text{ to } +0.2 \text{ V } (0 \text{ V TYP.})$ 

· LOW INSERTION LOSS:

0.6 dB TYP. @ DC to 1.0 GHz 0.8 dB TYP. @ 1.0 to 2.0 GHz 0.95 dB TYP. @ 2.0 to 2.5 GHz

· HIGH ISOLATION:

32.5 dB TYP. @ DC to 1.0 GHz 25 dB TYP. @ 1.0 to 2.0 GHz 22.5 dB TYP. @ 2.0 to 2.5 GHz

POWER HANDLING:

 $P_{in (0.1 dB)} = +17.0 dBm TYP. @ 1.0 GHz, V_{DD} = 2.8 V$  $P_{in (1 dB)} = +21.0 dBm TYP. @ 1.0 GHz, V_{DD} = 2.8 V$ 

• HIGH-DENSITY SURFACE MOUNT PACKAGE:

6-pin minimold package  $(1.5 \times 1.1 \times 0.55 \text{ mm})$ 

Pb-FREE

#### **DESCRIPTION**

NEC's UPD5710TK is a wide-band, single control CMOS MMIC SPDT (Single Pole Double Throw) switch for mobile communications, instrumentation, short range wireless, and general-purpose RF switching applications.

This device can operate from DC to 2.5GHz with low insertion loss and high isolation, and generally does not require blocking capacitors on the RF lines.

The UPD5710TK is housed in a Pb-Free 6-pin minimold (1511) package, suitable for high-density surface mounting.

#### **APPLICATIONS**

- MOBILE COMMUNICATIONS
- SET TOP BOXES
- SHORT RANGE WIRELESS
- INSTRUMENTATION

#### ORDERING INFORMATION

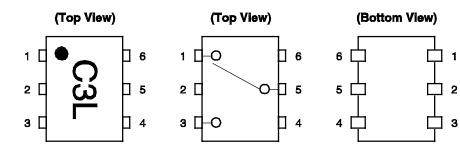
| PART NUMBER    | PACKAGE                        | MARKING | SUPPLYING FORM   |  |
|----------------|--------------------------------|---------|--|--|
| μPD5710TK-E2-A | 6-pinlead-less minimold (1511) | C3L     | Embossed tape 8 mm wide     Pin 1, 6 face the perforation side of the tape     Qty 5 kpcs/reel |  |

**Remark** To order evaluation samples, contact your nearby sales office.

Part number for sample order: UPD5710TK-A

\_California Eastern Laboratories

# PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



| PIN NO. | PIN NAME          |  |
|---------|-------------------|--|
| 1       | OUTPUT1           |  |
| 2       | GND               |  |
| 3       | OUTPUT2           |  |
| 4       | V <sub>cont</sub> |  |
| 5       | INPUT             |  |
| 6       | V <sub>DD</sub>   |  |

## **TRUTH TABLE**

| Vcont | INPUT-OUTPUT1 | INPUT-OUTPUT2 |  |
|-------|---------------|---------------|--|
| Low   | OFF           | ON            |  |
| High  | ON            | OFF           |  |

# ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

| PARAMETER                     | SYMBOL           | RATINGS     | UNIT |
|-------------------------------|------------------|-------------|------|
| Supply Voltage                | V <sub>DD</sub>  | +4.6        | ٧    |
| Switch Control Voltage        | Vcont            | +4.6        | ٧    |
| Continuous Current            | Idc              | 60          | mA   |
| Input Power                   | Pin              | +23         | dBm  |
| Operating Ambient Temperature | TA               | -45 to +85  | °C   |
| Storage Temperature           | T <sub>stg</sub> | -65 to +150 | °C   |

# RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

| PARAMETER                  | SYMBOL                | MIN. | TYP. | MAX. | UNIT |
|----------------------------|-----------------------|------|------|------|------|
| Supply Voltage             | V <sub>DD</sub>       | +1.8 | +2.8 | +3.3 | V    |
| Switch Control Voltage (H) | V <sub>cont (H)</sub> | +1.8 | +2.8 | +3.3 | V    |
| Switch Control Voltage (L) | Vcont (L)             | -0.2 | 0    | +0.2 | V    |

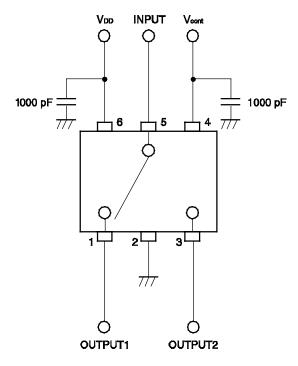
Notes 1.  $I V_{cont(H)} - V_{DD} I \le 0.1 V$ 

# **ELECTRICAL CHARACTERISTICS** (TA = +25°C, VDD = 2.8V, Vcont(H) = 2.8 V, Vcont(L) = 0 V, unless otherwise specified)

| PARAMETER                                 | SYMBOL           | TEST CONDITIONS                          | MIN.  | TYP.  | MAX. | UNIT |
|---|------------------|--|-------|-------|------|------|
| Insertion Loss 1                          | Lins1            | f = DC to 1.0 GHz                        | -     | 0.6   | 0.8  | dB   |
| Insertion Loss 2                          | Lins2            | f = 1.0 to 2.0 GHz                       | -     | 0.8   | 1.0  | dB   |
| Insertion Loss 3                          | Lins3            | f = 2.0 to 2.5 GHz                       | -     | 0.95  | 1.2  | dB   |
| Isolation 1                               | ISL1             | f = DC to 1.0 GHz                        | 30    | 32.5  | -    | dB   |
| Isolation 2                               | ISL2             | f = 1.0 to 2.0 GHz                       | 22    | 25    | -    | dB   |
| Isolation 3                               | ISL3             | f = 2.0 to 2.5 GHz                       | -     | 22.5  | -    | dB   |
| Input Return Loss                         | RLin             | f = DC to 2.5 GHz                        | 15    | 20    | -    | dB   |
| Output Return Loss                        | RLout            | f = DC to 2.5 GHz                        | 15    | 20    | -    | dB   |
| 0.1 dB Loss Compression Input Power Note  | Pin (0.1 dB)     | f = 1.0 GHz                              | +13.5 | +17.0 | -    | dBm  |
| 1 dB Loss Compression<br>Input Power Note | Pin (1 dB)       | f = 1.0 GHz                              | -     | +21.0 | -    | dBm  |
| Intermodulation Intercept Point           | IIP <sub>3</sub> | 2 tone, 1.000/1.001GHz,<br>1 MHz spacing | -     | +33   | -    | dBm  |
| Supply Current                            | IDD              | No RF                                    | -     | 0.01  | 1.0  | μΑ   |
| Switch Control Current                    | Icont            | No RF                                    | -     | 0.01  | 1.0  | μΑ   |
| Switch Control Speed                      | tsw              |  | _     | 30    | 50   | ns   |

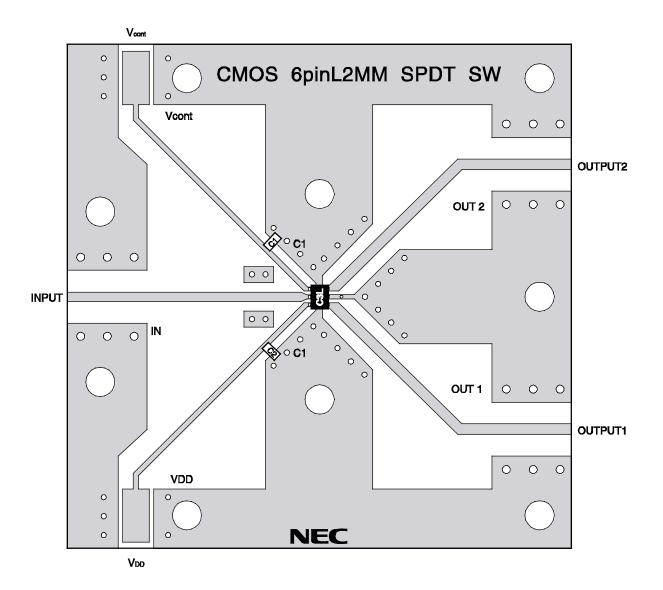
**Notes .**  $P_{in (0.1 dB)}$  or  $P_{in (1 dB)}$  are the measured input power level when the insertion loss increases 0.1 dB more or 1dB than that of linear range.

# **EVALUATION CIRCUIT**



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

## ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

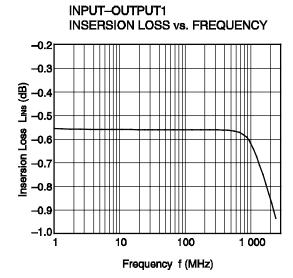


# **USING THE NEC EVALUATION BOARD**

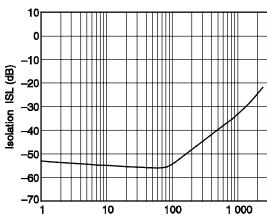
| SYMBOL | VALUES   |  |
|--------|----------|--|
| C1, C2 | 1,000 pF |  |

## **TYPICAL CHARACTERISTIC**

(TA = +25°C, VDD = 2.8 V, Vcont (H) = 2.8 V, Vcont (L) = 0 V, unless otherwise specified)

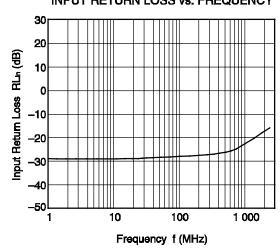




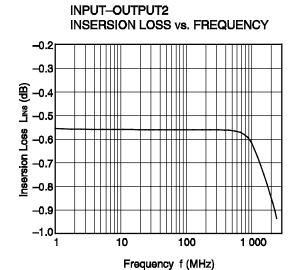


# INPUT-OUTPUT1 INPUT RETURN LOSS vs. FREQUENCY

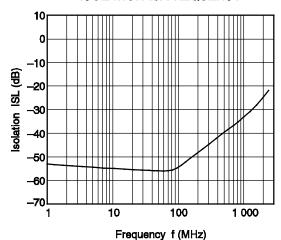
Frequency f (MHz)



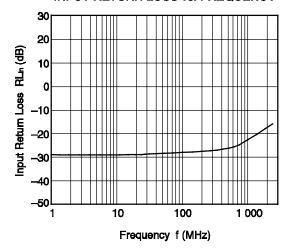
**Remark** The graphs indicate nominal characteristics.



# INPUT-OUTPUT2 ISOLATION vs. FREQUENCY

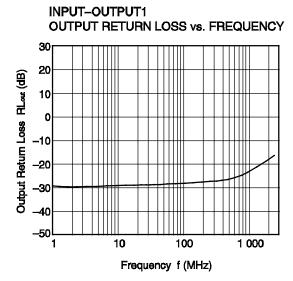


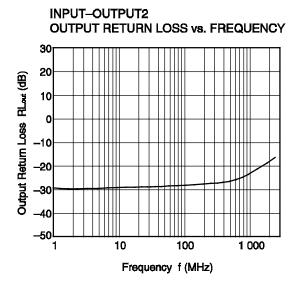
# INPUT-OUTPUT2 INPUT RETURN LOSS vs. FREQUENCY

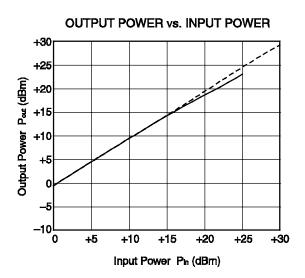


## TYPICAL CHARACTERISTIC

(TA =  $\pm 25$ °C, VDD = 2.8 V, Vcont (H) = 2.8 V, Vcont (L) = 0 V, unless otherwise specified)



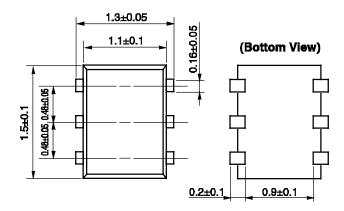


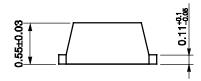


**Remark** The graphs indicate nominal characteristics.

# **PACKAGE DIMENSIONS**

# 6-PIN LEAD-LESS MINIMOLD (1511) (UNIT:mm)





## RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method | Soldering Conditions                                 |                      | Condition Symbol |
|------------------|--|----------------------|------------------|
| Infrared Reflow  | Peak temperature (package surface temperature)       | : 260°C or below     | IR260            |
|                  | Time at peak temperature                             | : 10 seconds or less |                  |
|                  | Time at temperature of 220°C or higher               | : 60 seconds or less |                  |
|                  | Preheating time at 120 to 180°C                      | : 120±30 seconds     |                  |
|                  | Maximum number of reflow processes                   | : 3 times            |                  |
|                  | Maximum chlorine content of rosin flux (% mass)      | : 0.2%(Wt.) or below |                  |
| VPS              | Peak temperature (package surface temperature)       | : 215°C or below     | VP215            |
|                  | Time at temperature of 200°C or higher               | : 25 to 40 seconds   |                  |
|                  | Preheating time at 120 to 150°C                      | : 30 to 60 seconds   |                  |
|                  | Maximum number of reflow processes                   | : 3 times            |                  |
|                  | Maximum chlorine content of rosin flux (% mass)      | : 0.2%(Wt.) or below |                  |
| Wave Soldering   | Peak temperature (molten solder temperature)         | : 260°C or below     | WS260            |
|                  | Time at peak temperature                             | : 10 seconds or less |                  |
|                  | Preheating temperature (package surface temperature) | : 120°C or below     |                  |
|                  | Maximum number of flow processes                     | : 1 time             |                  |
|                  | Maximum chlorine content of rosin flux (% mass)      | : 0.2%(Wt.) or below |                  |
| Partial Heating  | Peak temperature (pin temperature)                   | : 350°C or below     | HS350            |
|                  | Soldering time (per side of device)                  | : 3 seconds or less  |                  |
|                  | Maximum chlorine content of rosin flux (% mass)      | : 0.2%(Wt.) or below |                  |

Caution Do not use different soldering methods together (except for partial heating).

Life Support Applications

These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these products can reasonably be expected to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their own risk and agree to fully indemnify CEL for all damages resulting from such improper use or sale.

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